



Modulating electronic properties of β -Ga₂O₃ by strain engineering

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ABSTRACT

β -Ga₂O₃ is a promising material for the development of next-generation power electronic and optoelectronic devices due to its exceptional properties, including ultrawide bandgap and thermodynamic stability. Strain engineering has emerged as a powerful method to modulate the physical properties of materials and has been widely employed in semiconductor devices to enhance their performance and functionality. Our study focuses on the effects of strain engineering on the electronic properties of β -Ga₂O₃. Using density functional theory, we calculated the band structures and electron effective masses of β -Ga₂O₃ under different strain states. Our investigation revealed that strain manipulation can induce an indirect-direct bandgap transition. Strain can also lead to changes in effective masses and anisotropy of electron mobility. Our calculations provide important insights into the potential of strain engineering as a powerful tool for modulating the electronic properties of β -Ga₂O₃, with important implications for practical device applications.

Introduction

Gallium oxide (Ga₂O₃) is one of the ultra-wide bandgap semiconductor materials with excellent material properties that have been extensively studied for its potential in various fields, including solar-blind UV photodetectors, gas sensors, photocatalysts, light-emitting diodes, and high-power electronic devices [1–11]. Its wide bandgap makes it suitable for high-voltage applications [12], and its high n-type conductivity and large optical bandgap make it a promising transparent conducting oxide for UV optoelectronic devices [13]. Among the six different polymorphs of Ga₂O₃, the monoclinic β phase is the most abundant and stable, owing to its exceptional chemical and thermal stability [14].

It is widely recognized that strain engineering is a powerful approach for modulating physical properties and enhancing the performance of electronic and photonic devices [15–23]. Strained silicon technology, in particular, has been extensively used in modern microelectronics, including CMOS devices, optoelectronic devices, sensors, and logic devices [24]. Considering that Young's modulus of β -Ga₂O₃ (150–190

GPa) is close to Young's modulus of silicon (130–190 GPa) [25,26], strain engineering is also potentially feasible in the electronic property modulation of β -Ga₂O₃. Currently, strain engineering has been widely applied to Ga₂O₃ and Ga₂O₃-based materials. Theoretical predictions of the bandgap tunability of α -Ga₂O₃ by hydrostatic, uniaxial, and equibiaxial strains have been reported by Ref. [27]. Calculations for the effects of uniform and epitaxial strain on the band structure of κ -Ga₂O₃ are also illustrated [28]. However, limited experimental studies have explored the strain effects on bulk β -Ga₂O₃. One recent study examined the effects of hydrostatic strain on the electronic properties (such as band structure, carrier effective mass and carrier mobility) of β -Ga₂O₃, revealing its band gap modulation, phase transition behavior, and anisotropic characteristics [29]. Another experimental study demonstrated the modification of the bandgap in β -Ga₂O₃ sheet through elastic strain using a modified bending method [30]. These results demonstrate the promising potential of strain engineering as an effective approach to enhance the performance of β -Ga₂O₃-based devices.

Based on the aforementioned research, it is suggested that strain can modify the bandgap of β -Ga₂O₃, leading to changes in its physical

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properties. It is worth noting that β -Ga₂O₃ is an indirect-bandgap material [31], which can limit its light emission efficiency. Additionally, the n-type conductivity of β -Ga₂O₃ is comparatively lower than other semiconductor materials such as SiC and GaN, which can reduce device performance [32]. Therefore, achieving a direct bandgap of β -Ga₂O₃ and studying the impact of strain on the electron effective mass is crucial, as this property can affect the material's electron conductivity, ultimately influencing device performance. In our study, we specifically investigated the impact of different types of strain (uniaxial, biaxial, and isotropic) on the structural parameters, bandgap structure, and electron effective mass of β -Ga₂O₃. While the aforementioned study primarily focused on hydrostatic strain [29], which is a more reasonable choice compared to isotropic strain, they did not consider uniaxial and biaxial strain. In contrast, our study innovatively incorporated these strain types, which are easier to apply in practical applications such as epitaxial growth. The results of our calculations will be valuable for fully realizing the potential of strain-engineered β -Ga₂O₃ in power electronics and optical applications.

Method

The structure and electronic properties of β -Ga₂O₃ are calculated using the first-principles plane-wave pseudo-potential method based on density functional theory (DFT). All calculations are carried out by PWmat, a GPU-based plane-wave pseudopotential code for DFT simulations [33]. The exchange–correlation potential is employed through the generalized gradient approximation (GGA) within the Perdew-Burke-Ernzerhof (PBE) function [34] and Optimized Norm-Conserving-Vanderbilt pseudopotentials [35]. Plane-wave cut-off energy of 70 Ry have been used for all structures. Before property calculations, geometry optimization is required to be converged. The number of Monkhorst-Pack k-point sampling [36] in the Brillouin zone is $2 \times 9 \times 5$ for the structural relaxation of the conventional cell containing 20 atoms. Subsequently, the optimized cell structure is transformed into a primitive unit cell containing 10 atoms for saving calculation time. In

the self-consistent field (SCF) and density of states (DOS) calculations, the k-mesh-resolved value is set at the same accuracy level of 0.035 (in the unit of $2\pi/\text{\AA}$) using VASPKIT [37]. The convergence accuracy of total energy and force are 0.005 eV/atom and 0.005 eV/Å, respectively. The strain dependence of effective masses in the main CB valleys is evaluated. The carrier effective masses (m^*) is shown in Eq. (1)

$$\frac{1}{m^*} = \frac{1}{\hbar^2} \frac{\partial^2 E}{\partial k^2} \quad (1)$$

where m^* is the effective mass, \hbar is the reduced Planck constant, E indicates the energy, and k is the wave vector in the reciprocal lattice. The values of m^* are obtained by fitting the energy dispersion of conduction band minimum to a parabolic function along different k directions in the vicinity of Γ . For the sake of higher accuracy and computational feasibility, the GGA + U method is adopted (see the [Supplementary material](#) for more details).

Fig. 1(a) shows the conventional unit cell and polyhedra of β -Ga₂O₃. The lattice parameters of the conventional cell, $a = 12.05 \text{ \AA}$, $b = 3.00 \text{ \AA}$, $c = 5.74 \text{ \AA}$, and $\beta = 103.55^\circ$, are in good agreement with the previously reported values ($a = 12.23 \text{ \AA}$, $b = 3.04 \text{ \AA}$, $c = 5.80 \text{ \AA}$, and $\beta = 103.7^\circ$) [38]. There are two inequivalent Ga sites: Ga (I) and Ga (II). The Ga (I) atoms are bonded to four neighboring O atoms and the Ga (II) atoms are bonded to six neighboring O atoms. The calculated average bond lengths of Ga1-O and Ga2-O are 1.816 Å and 1.969 Å, respectively. Based on the calculated strain-free structure, the sizes of the strained lattice constants are determined. Three types of strain, uniaxial, biaxial, and isotropic strain with respect to three cell vectors a , b , and c are illustrated in Fig. 1 (b–d), where the directions of induced and optimized strain (ϵ_{ind} and ϵ_{opt}) are represented by arrows. The strains along the a -, b -, and c -axes are defined as $\epsilon_a = (a - a_0)/a_0$, $\epsilon_b = (b - b_0)/b_0$, and $\epsilon_c = (c - c_0)/c_0$, where a_0 , b_0 and c_0 are lattice constants at the strain-free state, respectively. Uniaxial strain is simulated by straining the lattice constant along b -axes while relaxing the other two constants. Biaxial strain is simulated by stretching the lattice constants along a - and c -axes

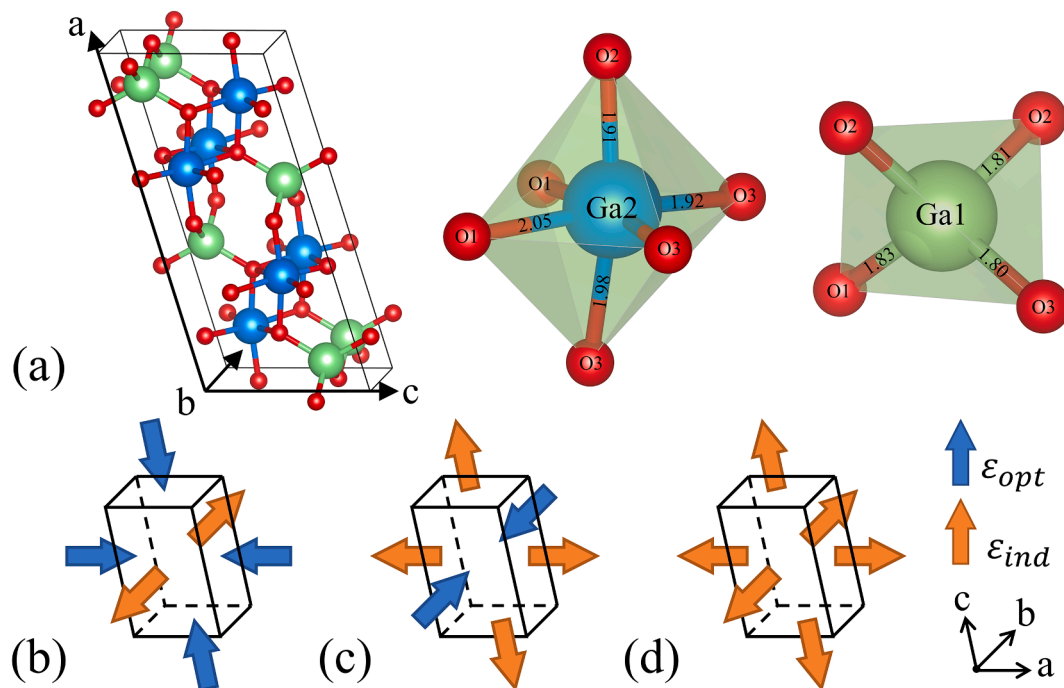


Fig. 1. (a) The conventional unit cell of β -Ga₂O₃ and the polyhedra of β -Ga₂O₃ with bond lengths and atom sites indicated. Schematic illustrations of (b) uniaxial (c) biaxial, and (d) isotropic strain models. The O atoms and two non-equivalent Ga atoms are distinguished by different colors. The orange and blue arrows represent induced strain (ϵ_{ind}) and optimized strain (ϵ_{opt}), respectively. (For interpretation of the references to colour in this figure legend, the reader is referred to the web version of this article.)

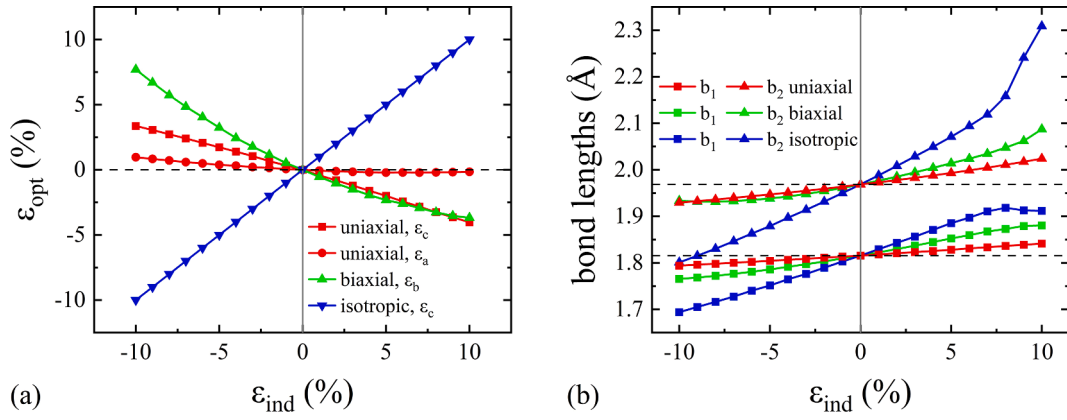


Fig. 2. (a) Optimized strain values and (b) bond lengths of β -Ga₂O₃ under different strain states: uniaxial, biaxial, and isotropic, which correspond to induced strain values.

simultaneously while relaxing that along b -axes. Isotropic strain is imposed by scaling all three lattice constants by the same factor. All calculations are carried out using 11 data points, covering a range of strain values from -10% to 10% , with a step of 1% .

Results and discussion

Lattice structure

The structure relaxation of strained β -Ga₂O₃ is performed firstly, and the results are shown in Fig. 2(a), which depicts the optimized changes in ϵ_a , ϵ_b , and ϵ_c as functions of the corresponding induced strain at each strain state.

In the application of uniaxial and biaxial strain models, the optimized strain is observed to decrease as the corresponding induced strain increases (see Fig. 2(a)). Of note is that the changes of optimized strain under uniaxial strain (ϵ_a and ϵ_c) are significantly smaller than that under biaxial strain (ϵ_b), with the biggest difference at -10% strain ($\epsilon_a = 3.36\%$, $\epsilon_c = 0.96\%$ vs. $\epsilon_b = 7.70\%$). According to the Poisson effect, the optimized strain tends to change in the opposite trend of induced strain. Since the Poisson ratio of biaxially strained β -Ga₂O₃ is higher, it is reasonable that the changes in the structural parameters under biaxial strain are more pronounced. This phenomena has also been reported in the theoretical calculations concerning α -Ga₂O₃ [27] and κ -Ga₂O₃ [28].

Fig. 2(b) depicts lattice deformation, described by strain-induced bond length changes. As shown in Fig. 1(a), β -Ga₂O₃ has two inequivalent Ga sites and three inequivalent O sites, and the bond lengths

Table 1

The maximum and minimum bandgap values and the corresponding strain values at each strain state.

State	Maximum		Minimum	
	E_g/eV	$\epsilon_{ind}(\%)$	E_g/eV	$\epsilon_{ind}(\%)$
Uniaxial ($\epsilon_{ind} = \epsilon_b$)	5.62	-9%	3.61	10%
Biaxial ($\epsilon_{ind} = \epsilon_{a,c}$)	5.15	-4%	3.23	10%
Isotropic ($\epsilon_{ind} = \epsilon_{a,b,c}$)	8.14	-10%	2.51	10%

between Ga1 (or Ga2) and the surrounding O atoms are close. Therefore, we calculated the average bond lengths of Ga1-O and Ga2-O, denoted as b_1 and b_2 , respectively. It is found from Fig. 2(b) that the bond length variation between Ga1-O and Ga2-O are more or less proportional to induced strain in the investigated strain range, which indicates that there are no qualitative changes in the electronic structure of our relaxed strain model. These results further confirmed that our calculations are justified under the given conditions.

Band structure

To have a complete image of the electronic band structure behavior under strains, the strain-induced changes on bandgaps are firstly determined. As given in the Supplementary material, the calculated band structure and DOS of unstrained β -Ga₂O₃ using GGA + U approach are represented in Fig. S1(a, b), yielding results close to other theoretical and experimental values [39–41]. Fig. 3(a–c) illustrates the strain

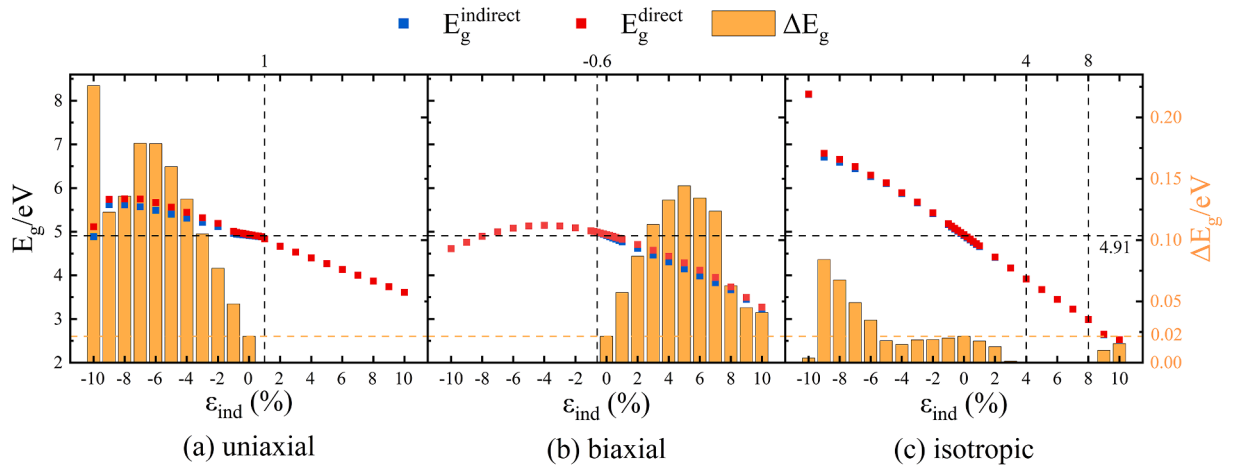


Fig. 3. Strain-induced effects on the bandgap of β -Ga₂O₃ as functions of (a) uniaxial, (b) biaxial, and (c) isotropic strain. The vertical lines indicate the strain point where indirect-to-direct transition occurs.

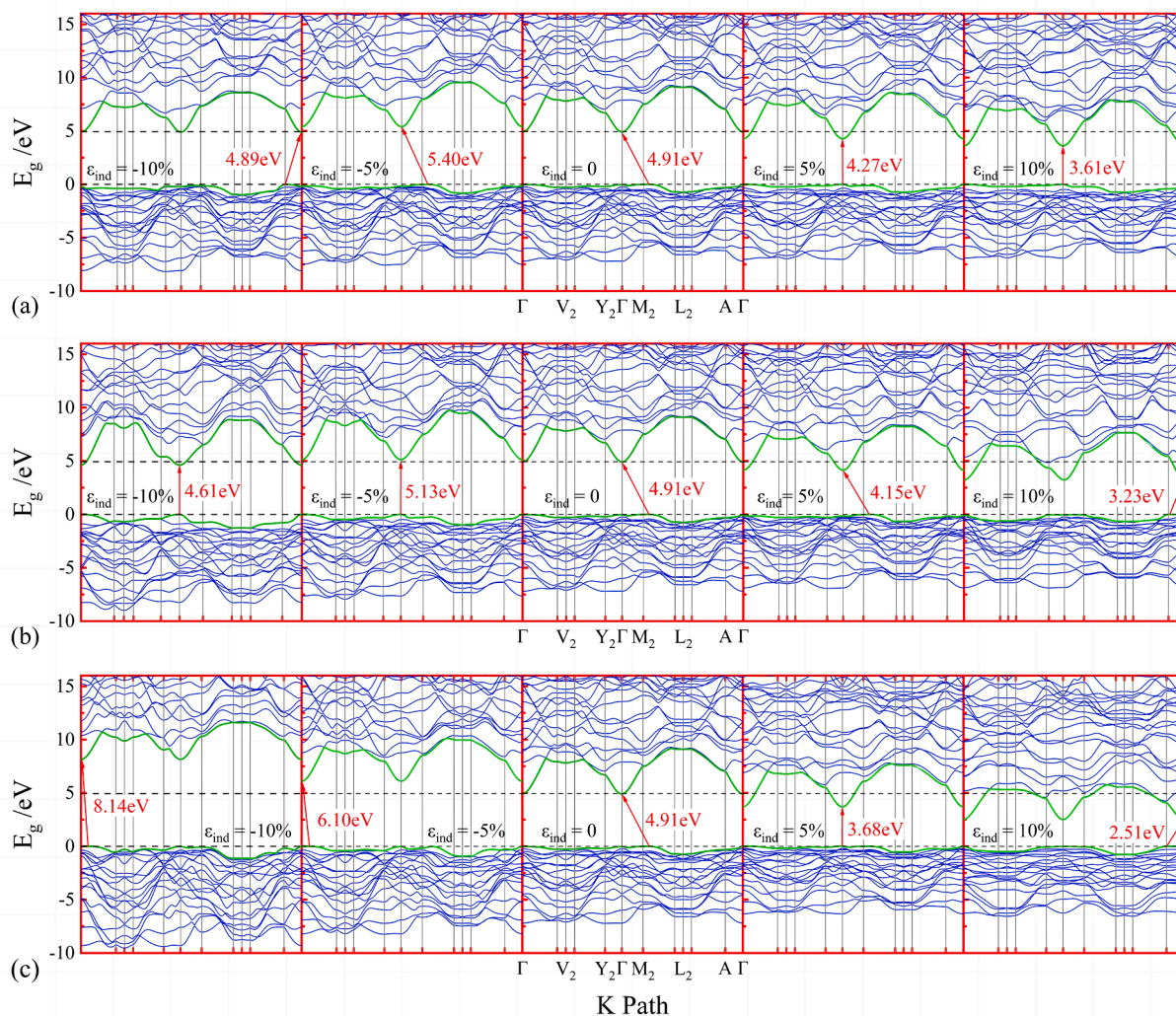


Fig. 4. Band structure evolution of β -Ga₂O₃ with respect to $\pm 10\%$ and $\pm 5\%$ (a) uniaxial, (b) biaxial, and (c) isotropic strain. The bandgap value of unstrained β -Ga₂O₃ (4.91 eV) is set as reference, the Fermi level is aligned to zero, and the arrows represent the directions from VBM to CBM.

Table 2

The average values of electron effective mass in β -Ga₂O₃ with different functionals, where m_0 is the free electron mass.

Functionals	m_e^*/m_0
GGA + U	0.353 (This work) 0.22–0.28 [54]
GGA	0.12–0.13 [48]
LDA	0.23–0.24 [45]
Gau-PBE	0.22–0.30 [49]
HSE06	0.39 [52] 0.28 [46]
B3LYP	0.34 [51]
Experiment	0.28 [40,50]

dependence of the direct bandgap E_g^{direct} , indirect bandgap E_g^{indirect} , and the energy difference ΔE_g ($\Delta E_g = E_g^{\text{direct}} - E_g^{\text{indirect}}$) for the three strain states: uniaxial, biaxial, and isotropic. The vertical lines indicate the strain point where indirect-to-direct bandgap transition occurs. Table 1 shows the list of maximum and minimum values of bandgap and the corresponding critical point under each strain state. It is known that achieving large strain in β -Ga₂O₃ can be challenging due to its relatively high elastic modulus and anisotropic monoclinic crystal structure [30].

Therefore, we conducted additional calculations for three different strain types within the range of -1% to 1% , with a step size of 0.2% . This finer approach enables a more detailed analysis of the strain-induced variations in bandgap and the transition from indirect to direct bandgap, as indicated in Fig. 3. The detailed figure, illustrating the comprehensive view of the bandgap variations within the -1% to 1% range, can be found in Fig. S2.

In the case of uniaxial or biaxial strain, the bandgap decreases as tension increases, while regarding compression, the bandgap slightly increases as compression increases within a certain range, and then begins to decrease with further compression, as indicated in Fig. 3(a, b). According to Table 1, the maximum bandgap value of 5.62 eV or 5.15 eV is achieved by applying compressive strain at -9% or -4% , respectively. On the other hand, the minimum bandgap value of 3.61 eV or 3.23 eV is observed under tensile strain at 10% . With regard to the isotropic strain, the bandgap evolution is almost linearly reduced as a function of strain (see Fig. 3(c)). The value of the bandgap decrease monotonously from 8.14 to 2.51 eV as the lattice strain increases within the investigated range. We note here that the change on the bandgap is significantly larger than that of uniaxial and biaxial strain, especially at -10% strain where drastic increasing of bandgap occurs, indicating the impact of isotropic change on the electronic property is stronger compared with the case of uniaxial and biaxial strain.

The underlying mechanism of bandgap evolution in β -Ga₂O₃ can be

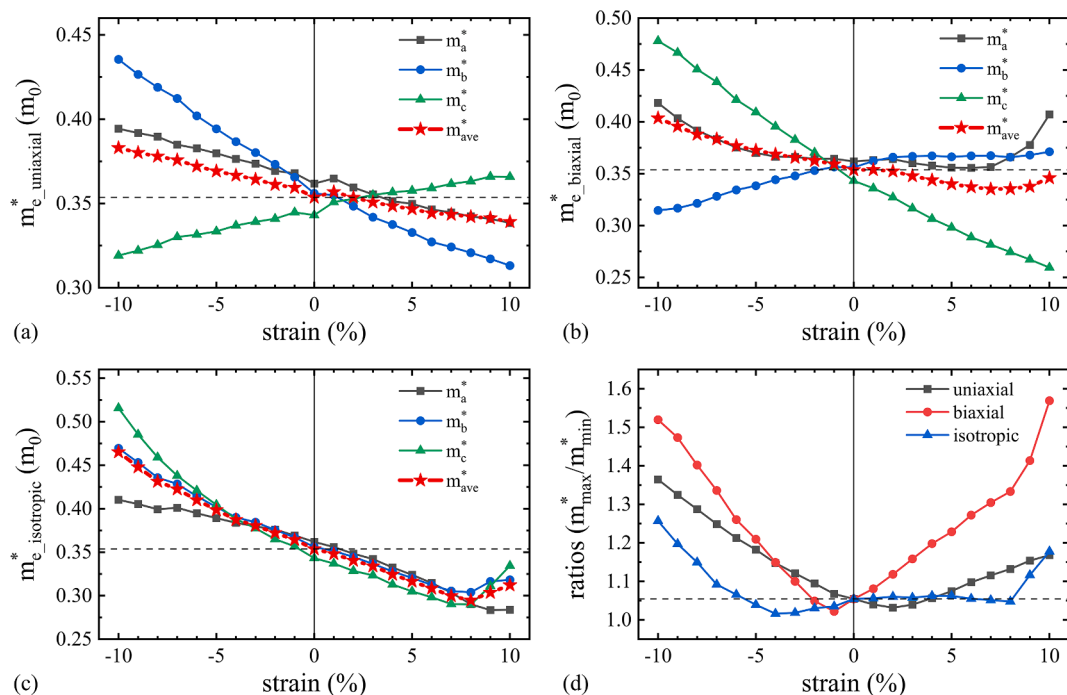


Fig. 5. Electron effective masses of β -Ga₂O₃ as functions of (a) uniaxial, (b) biaxial, and (c) isotropic strain and (d) changes on the electron effective mass ratio under each strain state. The dashed line represents the average electron effective mass and mass ratio of strain-free β -Ga₂O₃.

attributed to the strain-induced variations in the Ga-O bond length, which ultimately affect the distance between the conduction band and valence band. This phenomenon involves band repulsion, observed in various semiconductor and insulator materials [42,43], whereby the bandgap increases under compression and decreases under tension. However, when uniaxial or biaxial strain is applied, the light-hole (LH) band moves up under tensile strain, while the heavy-hole (HH) band moves up under compressive strain [15]. This leads to an inversion of the HH and LH bands at higher compression, resulting in a reduction of the bandgap with increasing compressive strain. This behavior has been reported in the literature for α -Ga₂O₃ [27] and κ -Ga₂O₃ [28] as well.

To understand the strain-induced changes in the bandgap characteristics in more detail, bandgap directness at each strain state is investigated, and the band structure of β -Ga₂O₃ at $\pm 10\%$ and $\pm 5\%$ strain is plotted in Fig. 4(a–c). The arrows represent the directions from VBM to CBM. Originally, the unstrained β -Ga₂O₃ features an indirect bandgap of 4.91 eV with the CBM at Γ point and the VBM at the Σ_{max} point along the M_2 -D line, which corresponds to that reported in Ref. [44]. Of note is that the CBM remains at Γ point of the Brillouin zone in all cases. However, the VBM shifts to different k points due to strain-induced changes in lattice symmetry and Brillouin zone size, which ultimately affects the bandgap and band-edge properties.

From Fig. 3(a–c) and Fig. 4(a–c), the indirect-to-direct bandgap transition generally appears in uniaxial or isotropic tensile strain, as well as at biaxial compressive strain. As indicated in Fig. 4(a), when uniaxial compression is applied, the VBM remains at the Σ_{max} point along M_2 -D line and changes to A point after exceeding $\sim 8\%$ strain. While under tension, the VBM undergoes a shift from the Σ_{max} point to Γ point after exceeding 1% strain, resulting in a direct bandgap for β -Ga₂O₃. Similar parabolic variation characters are also observed in the case of isotropic strain, as displayed in Fig. 4(c). The VBM remains at the Σ_{max} point along M_2 -D line and changes to Δ point, which is located near to the Γ point, for compressive strains exceeding -5% . When the tensile strain surpasses 4%, it becomes a direct-bandgap semiconductor. Of note is that, when the tensile strain exceeds 9%, the bandgap changes to indirect again with the VBM situated at A point. Intriguingly, for biaxial strain applied to β -Ga₂O₃, an opposite trend for the shift of bandgap directness is observed. The VBM remains at Σ_{max} point along M_2 -D line and

transitions to a point near the A point for tensile strains exceeding 8%. Conversely, for biaxial compressive strains greater than -0.6% , the VBM is located at the Γ point, as shown in Fig. 4(b).

When the strained β -Ga₂O₃ turns into a direct-bandgap semiconductor, it would exhibit a significant enhancement in its optical transitions around the fundamental adsorption edge, due to the elimination of phonon involvement to facilitate adsorption or emission. According to our results, the bandgap value of β -Ga₂O₃ can be modulated using strain engineering to exhibit better performance in power electronics and optical applications. Additionally, uniaxial or isotropic tensile strain and biaxial compressive strain can help to achieve direct gap material that benefits photon emission and absorption, indicating that bandgap tuning is manually feasible by introducing strain.

Electron effective mass

To further investigate the electron properties of β -Ga₂O₃, we calculated the effective mass under different strain states. Given the scarcity of p-type β -Ga₂O₃, we calculated the hole effective mass of β -Ga₂O₃, with the results detailed in the Supplementary material. However, due to the complex and highly anisotropic nature of hole effective mass and significant variations in previous results [45–47] for unstrained β -Ga₂O₃, establishing a clear relationship between hole effective mass and p-type conductivity remains challenging. Therefore, our study primarily focuses on electron effective mass. Specifically, we calculated the electron effective mass along three crystal directions (Γ -Y₂ [$-1\ 1\ 0$], Γ -M₂ [$-1\ 1\ 1$], and Γ -A [$0\ 0\ 1$]), denoted as m_a^* , m_b^* , m_c^* respectively. As presented in the Supplementary material, the electron effective mass of unstrained β -Ga₂O₃ is nearly isotropic. Reported results for the electron effective mass in β -Ga₂O₃ exhibit a wide range of values depending on different functionals and software methods [40,48–54,45,46], as shown in Table 2. Due to the differences in methodologies used in Functional analysis, there may be variations in band structure, such as the bandgap values. Thus, the determination of mass, relying on CBM, is prone to discrepancies resulting from variations in functional approaches. Additionally, although both our study and Ref. [54] employed GGA + U, it is important to note that differences in the assigned U values might

contribute to the divergent mass results obtained. Nonetheless, Our calculated average value of the electron effective mass in β -Ga₂O₃ (0.353 m_0) aligns consistently with several previous studies [51,52].

Next, we analyzed the dependence of electron effective mass of β -Ga₂O₃ on different strain states. The corresponding results are shown in Fig. 5(a–c). The strain-induced change on electron effective mass is discussed by considering the average value of the electron effective mass (m_{ave}^*) in the three directions. For qualitative investigation of anisotropy, the ratio of the maximum and minimum values ($m_{\text{max}}^*/m_{\text{min}}^*$) in m_a^* , m_b^* , m_c^* is introduced, as shown in Fig. 5(d). The values of m_{ave}^*/m_0 and $m_{\text{max}}^*/m_{\text{min}}^*$ at different strain states are listed in Table S2.

A closer inspection of changes in the band structure with the increase in strain reveals that as the bandgap shrinks, the electron valleys at the CBM become increasingly “sharp” (see Fig. 4). In fact, from the k - p perturbation theory, electron effective mass (m_c^*) at the Γ point is approximately proportional to the bandgap value [55,56]. In each strain state, there is an almost linearly decreasing relationship between electron effective mass and strain, as shown in Fig. 5(a–c). We observed a modest decrease in m_{ave}^* with increasing isotropic strain (from 0.478 to 0.312), except for high applied tensile strain (>8%), while the variation of m_{ave}^* under biaxial strain exhibits a similar decreasing trend (from 0.450 to 0.346). When uniaxial strain is applied, a slight reduction (from 0.351 to 0.339) of the electron effective mass is also observed. From Fig. 5(d) and Table S2, we can arrive at a qualitative conclusion that the increasing uniaxial or biaxial strain at a critical point can cause the increasing mass ratios, while the anisotropy is found to be practically unchanged under isotropic strain (see Fig. 5(c)). Since the electron mobility $\mu = q\tau/m_c^*$ is determined by electron effective mass, it is theoretically possible that the enhancement in the carrier mobility and electronic anisotropy can be achieved by increasing strain, with the correlated modulation on electron effective mass and mass ratios.

Conclusion

In summary, we have systematically studied the effect of strain on the crystal structure and electronic property of β -Ga₂O₃. It has been found that the bandgap monotonically decreases as the lattice constant increases in the isotropic strain case. However, in the case of uniaxial or biaxial strain, the bandgap decreases when the compressive strain exceeds a certain level. In most cases, for uniaxial or isotropic strain, β -Ga₂O₃ undergoes an indirect-to-direct bandgap transition under tensile strain and remains indirect for compressive strain, whereas for the biaxial strain, the shift of bandgap directness exhibits an almost opposite trend. Besides bandgap, our effective mass calculations show that the electron effective mass generally features a negative correlation with strain. Notably, the anisotropy of electron effective mass shows an upward trend in fluctuations under tension or compression. Our work can provide theoretical basis and experimental guidance for the development of β -Ga₂O₃-based devices by strain engineering.

CRediT authorship contribution statement

Ruijia Zhang: Investigation, Methodology, Writing – original draft. **Min Li:** Investigation, Methodology, Writing – original draft. **Gai Wu:** Resources, Software. **Lijie Li:** Writing – review & editing. **Zhaofu Zhang:** Formal analysis. **Kang Liang:** Investigation, Methodology, Writing – review & editing. **Wei Shen:** Conceptualization, Investigation, Methodology, Writing – review & editing, Resources, Software. **Ruijia Zhang and Min Li** contributed equally to this work.

Declaration of Competing Interest

The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.

Data availability

Data will be made available on request.

Acknowledgements

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Appendix A. Supplementary data

See [Supplementary material](#) for the complete calculation details and results of strain-engineered β -Ga₂O₃. Supplementary data to this article can be found online at <https://doi.org/10.1016/j.rinp.2023.106916>.

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